

## N And P-Channel Enhancement Mode MOSFET

### Description

The HM4616D uses advanced trench technology to provide excellent  $R_{DS(ON)}$  and low gate charge. The complementary MOSFETs may be used to form a level shifted high side switch, and for a host of other applications.

### General Features

- ◆ N-channel:

$V_{DS} = 30V, ID = 35A$

$R_{DS(ON)} = 5.5m\Omega$  (typical) @  $VGS = 10V$

$R_{DS(ON)} = 7.8m\Omega$  (typical) @  $VGS = 4.5V$

- ◆ P-Channel:

$V_{DS} = -30V, ID = -18A$

$R_{DS(ON)} = 15m\Omega$  (typical) @  $VGS = -10V$

$R_{DS(ON)} = 20m\Omega$  (typical) @  $VGS = -4.5V$

- ◆ Excellent gate charge  $\times R_{DS(ON)}$  product(FOM)
- ◆ Very low on-resistance  $R_{DS(ON)}$
- ◆ 150 °C operating temperature
- ◆ Pb-free lead plating
- ◆ 100% UIS tested

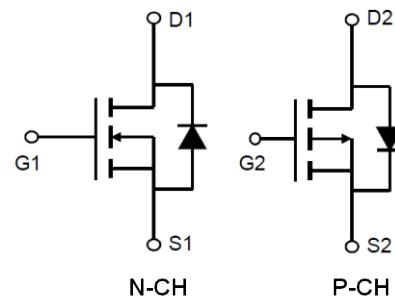
*100% UIS TESTED!*

*100%  $\Delta Vds$  TESTED!*

### Application

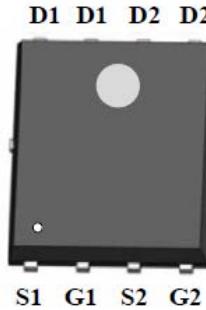
- ◆ Pch+Nch Complementary MOSFET for DC-FAN
- ◆ H-Bridge application

### Schematic diagram



### Marking and pin assignment

PDFN5×6-8L



Top View



Bottom View

### Ordering Information

Part Number	Storage Temperature	Package	Devices Per Reel
HM4616D	-55°C to +150°C	PDFN5×6-8L	5000

### Absolute Maximum Ratings (TA=25°C unless otherwise noted)

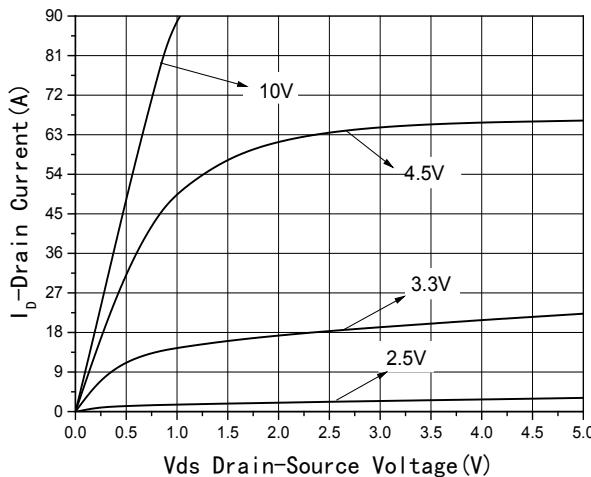
Parameter	Symbol	Limit		Unit
		N	P	
Drain-source voltage	$V_{DS}$	30	-30	V
Gate-source voltage	$V_{GS}$	$\pm 20$	$\pm 20$	V
Operating junction Temperature range	$T_j$	-55—150	-55—150	°C
Drain Current-Continuous (Silicon Limited)	$I_D$	35	-18	A
		24.5	-12.6	

Pulsed Drain Current (Package Limited)		I <sub>DM</sub>	105	-54	A
Avalanche Current <sup>C</sup>		I <sub>AS</sub> , I <sub>AR</sub>	22	-27	A
Avalanche energy L=0.1mH <sup>C</sup>		E <sub>AS</sub> , E <sub>AR</sub>	24	36	mJ
Power Dissipation <sup>B</sup>	T <sub>A</sub> =25°C	P <sub>D</sub>	12	20	W
	T <sub>A</sub> =75°C		5	8	
Junction and Storage Temperature Range		T <sub>J</sub> , T <sub>STG</sub>	-55—150		°C

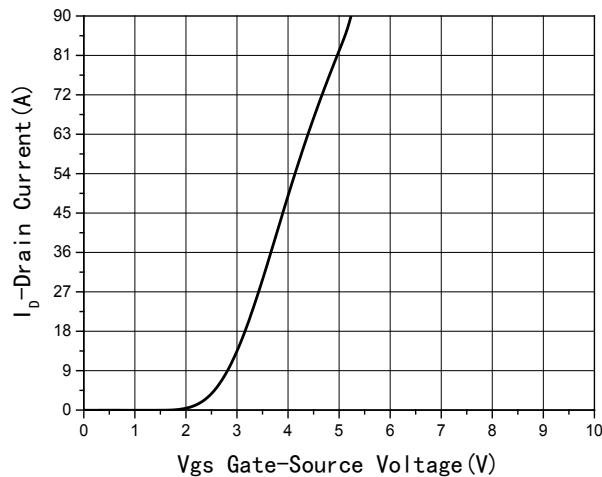
### N-Channel Electrical Characteristics (T<sub>J</sub>=25°C unless otherwise noted)

Parameter	Symbol	Condition	Min	Typ	Max	Unit
<b>OFF Characteristics</b>						
Drain-source breakdown voltage	BV <sub>DSS</sub>	V <sub>GS</sub> =0V, I <sub>D</sub> =250μA	30	-	-	V
Zero gate voltage drain current	I <sub>DSS</sub>	V <sub>DS</sub> =30V, V <sub>GS</sub> =0V	-	-	1	μA
Gate-body leakage	I <sub>GSS</sub>	V <sub>DS</sub> =0V, V <sub>GS</sub> =±20V	-	-	±100	nA
<b>ON Characteristics</b>						
Gate threshold voltage	V <sub>GS(th)</sub>	V <sub>DS</sub> =V <sub>GS</sub> , I <sub>D</sub> =250μA	1.0	1.5	2.5	V
Drain-source on-state resistance	R <sub>DS(ON)</sub>	V <sub>GS</sub> =10V, I <sub>D</sub> =13A	-	5.5	7.0	mΩ
		V <sub>GS</sub> =4.5V, I <sub>D</sub> =13A	-	7.8	12	
Forward transconductance	g <sub>fs</sub>	V <sub>DS</sub> =5V, I <sub>D</sub> =20A	-	43	-	S
<b>Dynamic Characteristics</b>						
Input capacitance	C <sub>ISS</sub>	V <sub>DS</sub> =15V, V <sub>GS</sub> =0V f=1.0MHz	-	985	-	pF
Output capacitance	C <sub>OSS</sub>		-	132	-	
Reverse transfer capacitance	C <sub>RSS</sub>		-	114	-	
Gate resistance	R <sub>g</sub>	V <sub>GS</sub> =0V, V <sub>DS</sub> =0V, f=1.0MHz	-	1.6	2.4	Ω
<b>Switching Characteristics</b>						
Turn-on delay time	t <sub>D(ON)</sub>	V <sub>DS</sub> =15V V <sub>GS</sub> =10V R <sub>L</sub> =1.5Ω R <sub>GEN</sub> =3Ω	-	4.4	-	ns
Rise time	t <sub>r</sub>		-	9	-	
Turn-off delay time	t <sub>D(OFF)</sub>		-	17	-	
Fall time	t <sub>f</sub>		-	6	-	
Total gate charge	Q <sub>g</sub>	V <sub>DS</sub> =15V, I <sub>D</sub> =13A V <sub>GS</sub> =10V	-	19.9	-	nC
Gate-source charge	Q <sub>gs</sub>		-	3.7	-	
Gate-drain charge	Q <sub>gd</sub>		-	4	-	

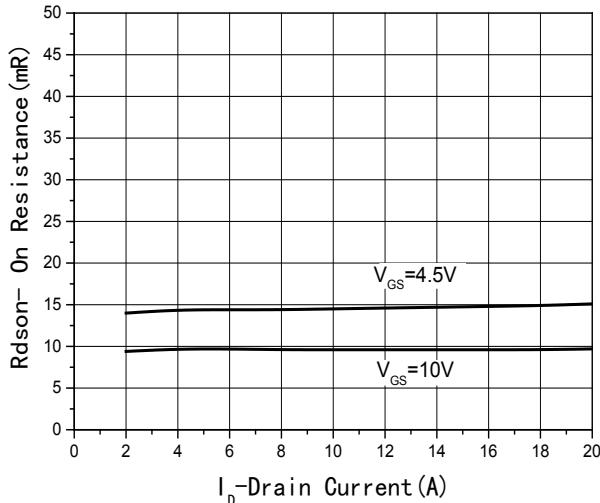
## Typical Performance Characteristics



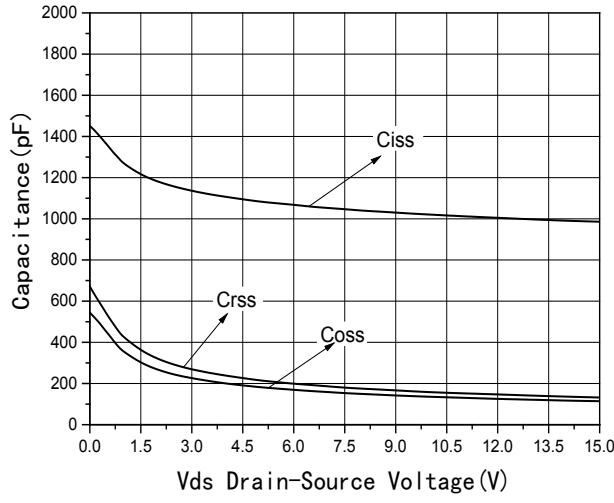
**Fig1 Output Characteristics**



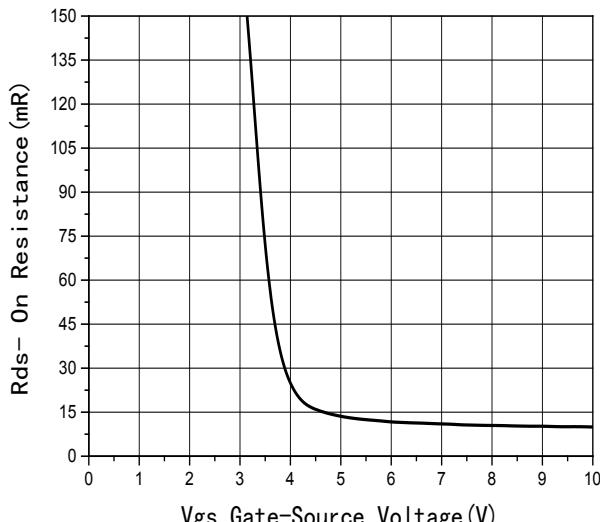
**Fig2 Transfer Characteristics**



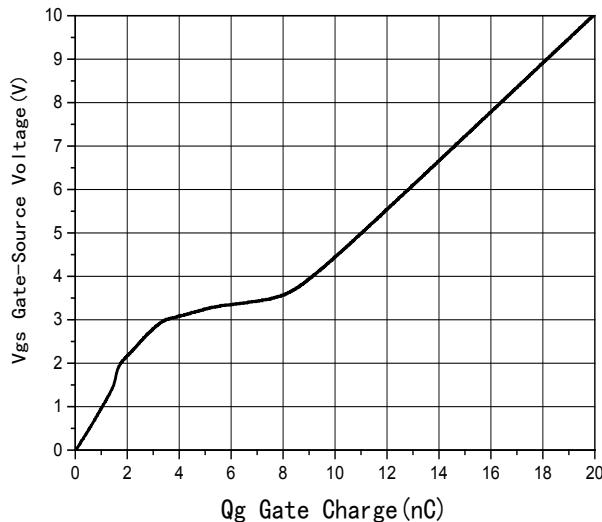
**Fig3 Rdson-Drain current**



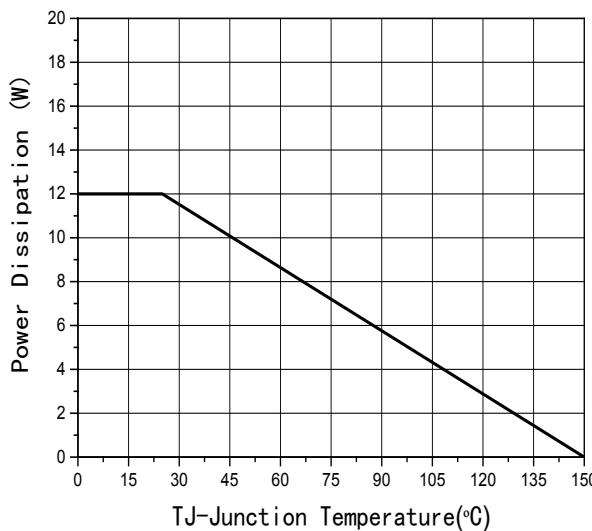
**Fig4 Capacitance vs Vds**



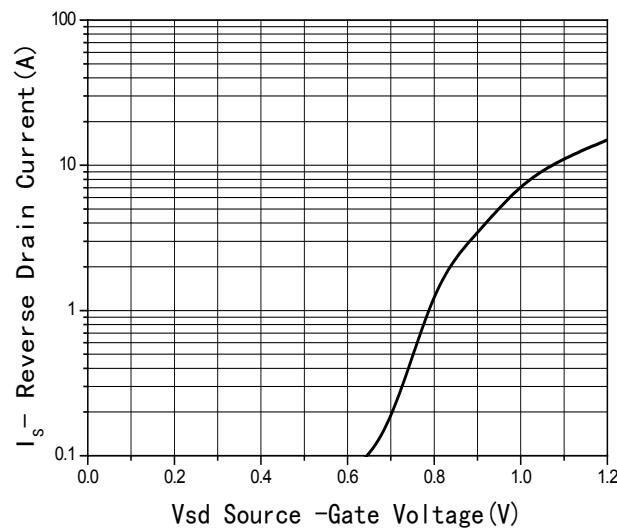
**Fig5 Rdson-Gate Drain voltage**



**Fig6 Gate Charge**



**Fig7 Power De-rating**



**Fig8 Source-Drain Diode Forward**

### P-Channel Electrical Characteristics ( $T_J=25^\circ\text{C}$ unless otherwise noted)

Parameter	Symbol	Condition	Min	Typ	Max	Unit
<b>OFF Characteristics</b>						
Drain-source breakdown voltage	$\text{BV}_{\text{DSS}}$	$\text{V}_{\text{GS}}=0\text{V}, \text{I}_D=-250\mu\text{A}$	-30	-	-	V
Zero gate voltage drain current	$\text{I}_{\text{DSS}}$	$\text{V}_{\text{DS}}=-30\text{V}, \text{V}_{\text{GS}}=0\text{V}$	-	-	-1	$\mu\text{A}$
Gate-body leakage	$\text{I}_{\text{GSS}}$	$\text{V}_{\text{DS}}=0\text{V}, \text{V}_{\text{GS}}=\pm20\text{V}$	-	-	$\pm100$	nA
<b>ON Characteristics</b>						
Gate threshold voltage	$\text{V}_{\text{GS(th)}}$	$\text{V}_{\text{DS}}=\text{V}_{\text{GS}}, \text{I}_D=-250\mu\text{A}$	-1	-1.5	-2.4	V
Drain-source on-state resistance	$\text{R}_{\text{DS(ON)}}$	$\text{V}_{\text{GS}}=-10\text{V}, \text{I}_D=-20\text{A}$	-	15	18	$\text{m}\Omega$
		$\text{V}_{\text{GS}}=-4.5\text{V}, \text{I}_D=-20\text{A}$	-	20	25	
Forward transconductance	$\text{g}_{\text{fs}}$	$\text{V}_{\text{DS}}=-5\text{V}, \text{I}_D=-10\text{A}$	-	18	-	S
<b>Dynamic Characteristics</b>						
Input capacitance	$\text{C}_{\text{ISS}}$	$\text{V}_{\text{DS}}=-15\text{V}, \text{V}_{\text{GS}}=0\text{V}$ $f=1.0\text{MHz}$	-	24	-	pF
Output capacitance	$\text{C}_{\text{OSS}}$		-	4.6	-	
Reverse transfer capacitance	$\text{C}_{\text{RSS}}$		-	4.2	-	
Gate resistance	$\text{R}_g$	$\text{V}_{\text{GS}}=0\text{V}, \text{V}_{\text{DS}}=0\text{V}$ , $f=1.0\text{MHz}$	-	4	-	$\Omega$
<b>Switching Characteristics</b>						
Turn-on delay time	$\text{t}_{\text{D(ON)}}$	$\text{V}_{\text{DS}}=-15\text{V}$ $\text{V}_{\text{GS}}=-10\text{V}$ $\text{R}_L=2.3\Omega$ $\text{R}_{\text{GEN}}=3\Omega$	-	10	-	ns
Rise time	$\text{tr}$		-	5.5	-	
Turn-off delay time	$\text{t}_{\text{D(OFF)}}$		-	3.6	-	
Fall time	$\text{tf}$		-	4.6	-	
Total gate charge	$\text{Q}_g$	$\text{V}_{\text{DS}}=-15\text{V}, \text{I}_D=-20\text{A}$ $\text{V}_{\text{GS}}=-10\text{V}$	-	1261	-	nC
Gate-source charge	$\text{Q}_{\text{gs}}$		-	152	-	
Gate-drain charge	$\text{Q}_{\text{gd}}$		-	137	-	

## Typical Performance Characteristics

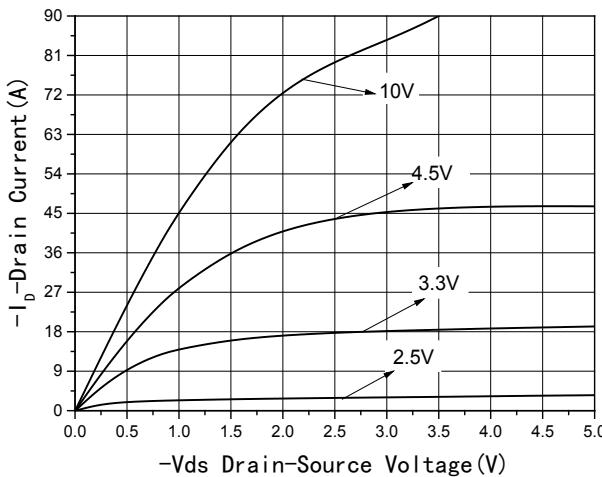


Fig1 Output Characteristics

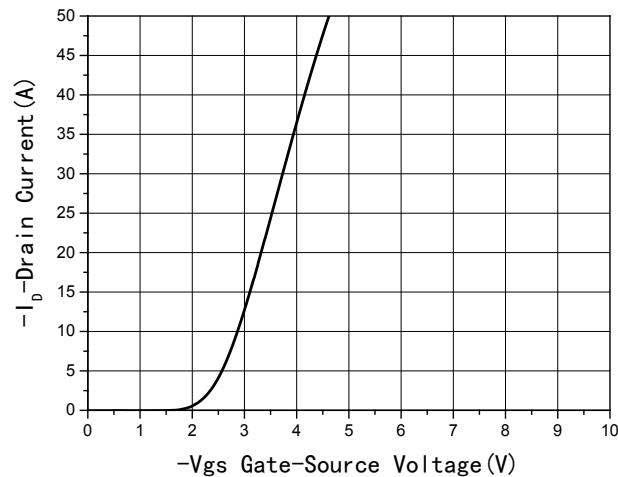


Fig2 Transfer Characteristics

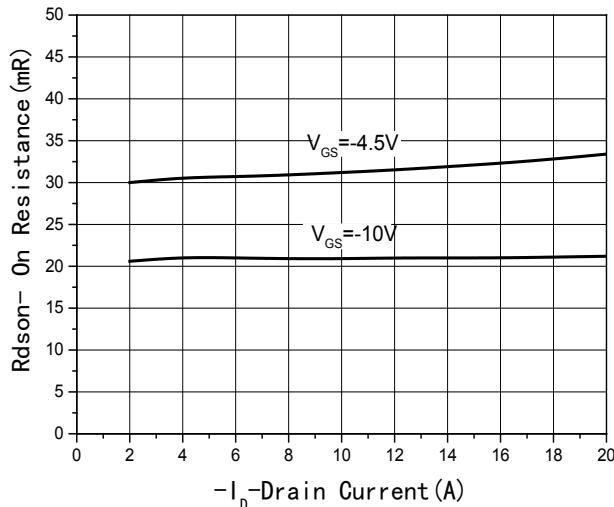


Fig3 Rdson-Drain current

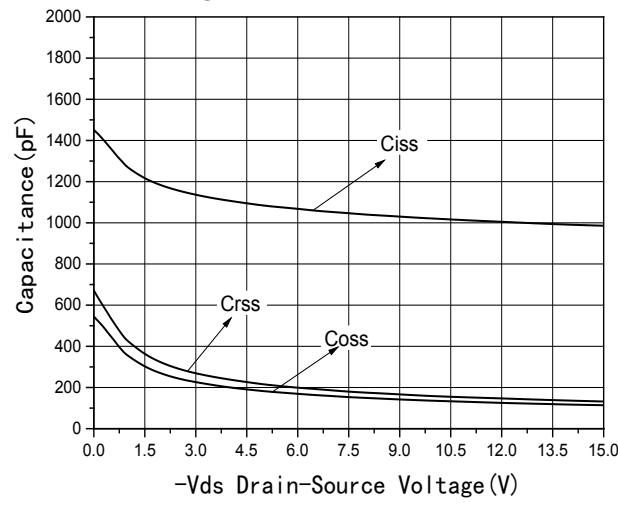


Fig4 Capacitance vs Vds

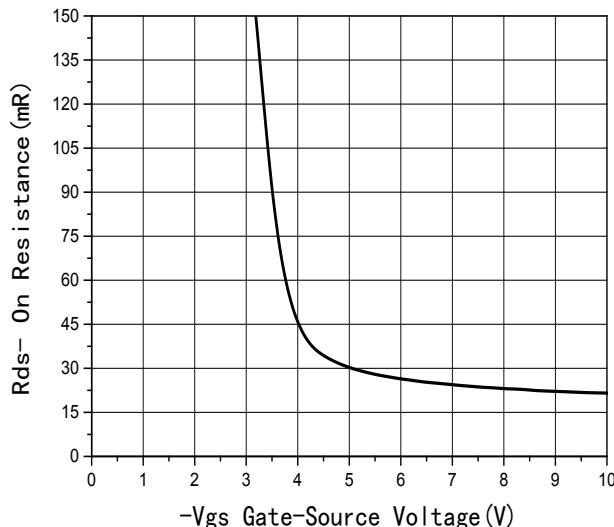


Fig5 Rdson-Gate Drain voltage

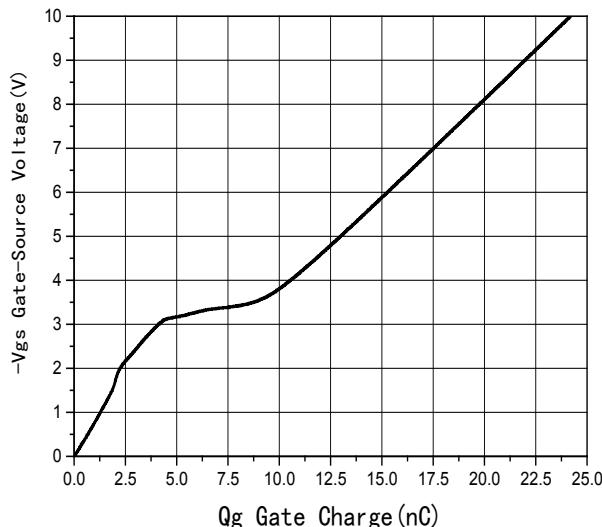


Fig6 Gate Charge

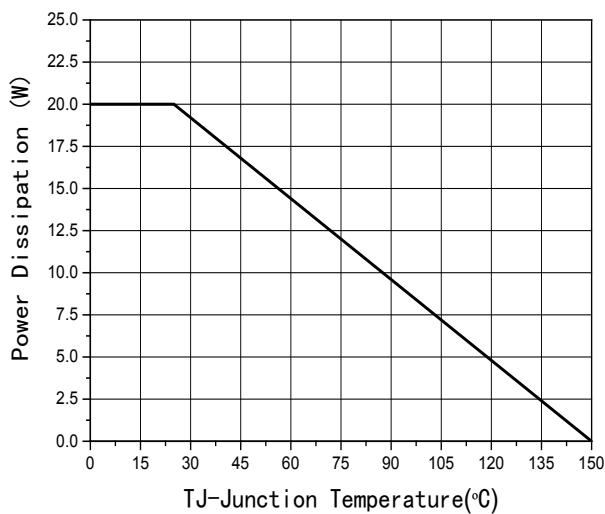


Fig7 Power De-rating

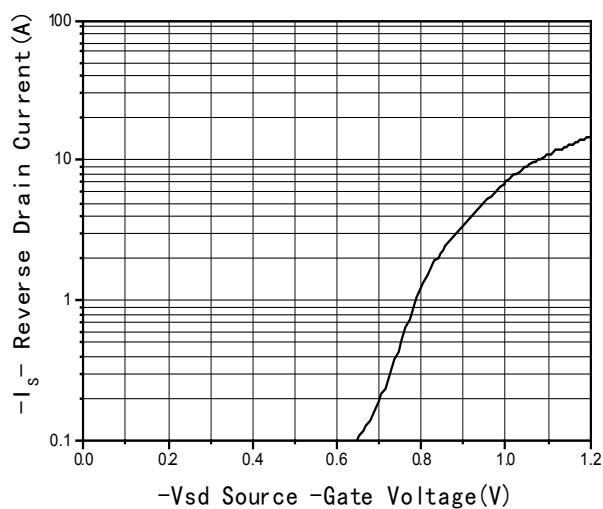
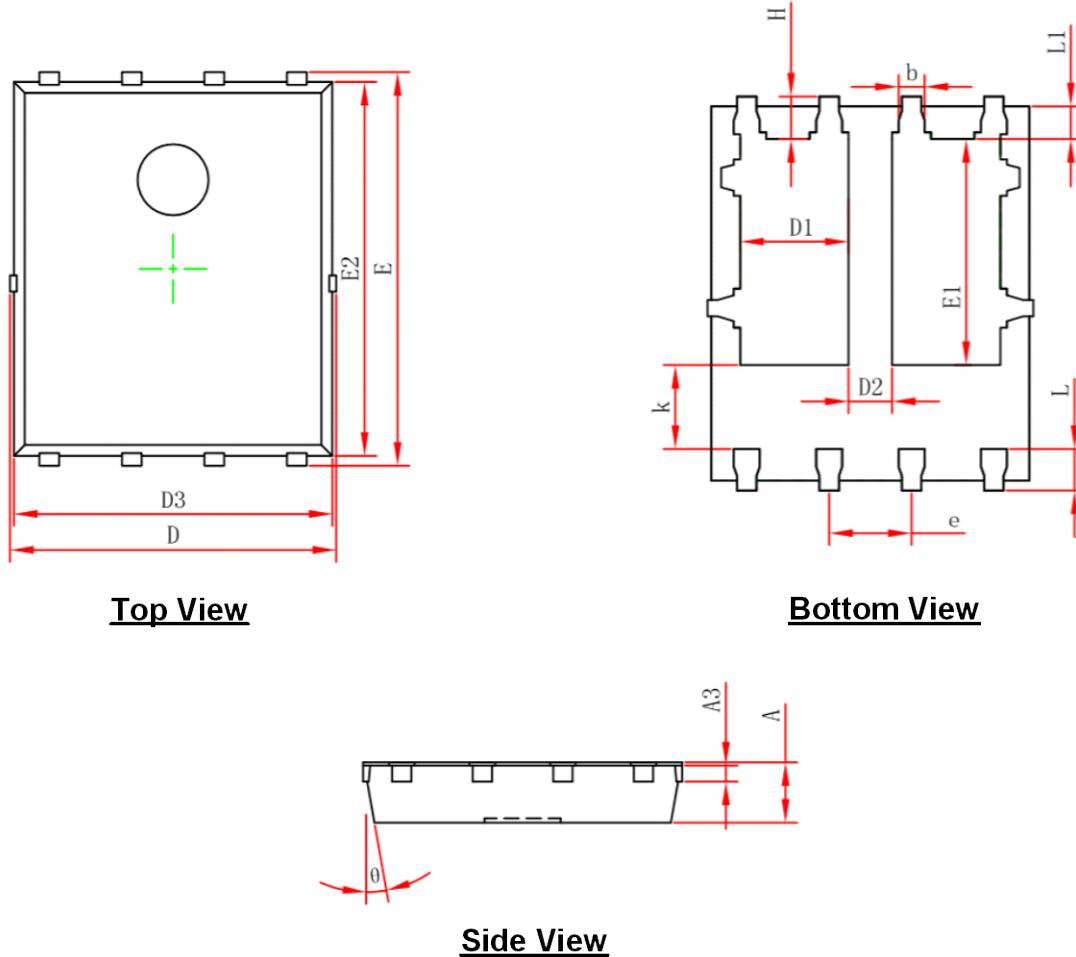


Fig8 Source-Drain Diode Forward

## Package Information

- PDFN5x6-8L



Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min.	Max.	Min.	Max.
A	0.900	1.000	0.035	0.039
A3	0.154REF.		0.006REF.	
D	4.944	5.096	0.195	0.201
E	5.974	6.126	0.235	0.241
D1	1.470	1.870	0.058	0.074
D2	0.470	0.870	0.019	0.034
E1	3.375	3.575	0.133	0.141
D3	4.824	4.976	0.190	0.196
E2	5.674	5.826	0.223	0.229
k	1.190	1.390	0.047	0.055
b	0.350	0.450	0.014	0.018
e	1.270TYP.		0.050TYP.	
L	0.559	0.711	0.022	0.028
L1	0.424	0.576	0.017	0.023
H	0.574	0.726	0.023	0.029
θ	10°		12°	